## NTP75N06, NTB75N06

## Power MOSFET

75 Amps, 60 Volts

## N-Channel TO-220 and D2PAK

Designed for low voltage, high speed switching applications in power supplies, converters and power motor controls and bridge circuits.

## Typical Applications

- Power Supplies
- Converters
- Power Motor Controls
- Bridge Circuits

MAXIMUM RATINGS $\left(T_{J}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Drain-to-Source Voltage | $\mathrm{V}_{\text {DSS }}$ | 60 | Vdc |
| Drain-to-Gate Voltage ( $\mathrm{R}_{\mathrm{GS}}=10 \mathrm{M} \Omega$ ) | V DGR | 60 | Vdc |
| Gate-to-Source Voltage <br> - Continuous <br> - Non-Repetitive ( $\mathrm{t}_{\mathrm{p}} \leq 10 \mathrm{~ms}$ ) | $\begin{aligned} & \mathrm{V}_{\mathrm{GS}} \\ & \mathrm{~V}_{\mathrm{GS}} \end{aligned}$ | $\begin{aligned} & \pm 20 \\ & \pm 30 \end{aligned}$ | Vdc |
| Drain Current <br> -Continuous @ $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ <br> - Continuous @ $\mathrm{T}_{\mathrm{A}}=100^{\circ} \mathrm{C}$ <br> - Single Pulse ( $\mathrm{t}_{\mathrm{p}} \leq 10 \mu \mathrm{~s}$ ) | $\begin{array}{r} \text { ID } \\ \text { ID } \\ \text { IDM } \\ \hline \end{array}$ | $\begin{gathered} 75 \\ 50 \\ 225 \end{gathered}$ | Adc <br> Apk |
| Total Power Dissipation @ $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ Derate above $25^{\circ} \mathrm{C}$ Total Power Dissipation @ $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $\mathrm{PD}_{\mathrm{D}}$ | $\begin{gathered} \hline 214 \\ 1.4 \\ 2.4 \end{gathered}$ | $\begin{gathered} \mathrm{W} \\ \mathrm{~W} /{ }^{\circ} \mathrm{C} \\ \mathrm{~W} \end{gathered}$ |
| Operating and Storage Temperature Range | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ | $\begin{gathered} -55 \text { to } \\ +175 \end{gathered}$ | ${ }^{\circ} \mathrm{C}$ |
| $\begin{aligned} & \text { Single Pulse Drain-to-Source Avalanche } \\ & \text { Energy - Starting } \mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \\ & \left(\mathrm{~V}_{\mathrm{DD}}=50 \mathrm{Vdc}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{Vdc}, \mathrm{~L}=0.3 \mathrm{mH}\right. \\ & \left.\mathrm{I}_{\mathrm{L}(\mathrm{pk})}=75 \mathrm{~A}, \mathrm{~V}_{\mathrm{DS}}=60 \mathrm{Vdc}\right) \end{aligned}$ | $\mathrm{EAS}^{\text {A }}$ | 844 | mJ |
| Thermal Resistance <br> - Junction-to-Case <br> - Junction-to-Ambient | $\begin{aligned} & R_{\theta J C} \\ & R_{\theta J A} \end{aligned}$ | $\begin{gathered} 0.7 \\ 62.5 \end{gathered}$ | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Maximum Lead Temperature for Soldering Purposes, $1 / 8^{\prime \prime}$ from case for 10 seconds | TL | 260 | ${ }^{\circ} \mathrm{C}$ |



## ON Semiconductor ${ }^{\text {w }}$

http://onsemi.com


ORDERING INFORMATION

| Device | Package | Shipping |
| :--- | :---: | :---: |
| NTP75N06 | TO-220AB | 50 Units/Rail |
| NTB75N06 | D2PAK | 50 Units/Rail |
| NTB75N06T4 | D2PAK | 800/Tape \& Reel |

ELECTRICAL CHARACTERISTICS $\left(\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS |  |  |  |  |  |
| Drain-to-Source Breakdown Voltage (Note 1.) $\left(\mathrm{V}_{\mathrm{GS}}=0 \mathrm{Vdc}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{Adc}\right)$ <br> Temperature Coefficient (Positive) | $\mathrm{V}_{(\mathrm{BR}) \mathrm{DSS}}$ | $60$ | $\begin{aligned} & 71 \\ & 73 \end{aligned}$ | - | $\begin{gathered} \mathrm{Vdc} \\ \mathrm{mV} /{ }^{\circ} \mathrm{C} \end{gathered}$ |
| $\begin{aligned} & \text { Zero Gate Voltage Drain Current } \\ & \left(\mathrm{V}_{\mathrm{DS}}=60 \mathrm{Vdc}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{Vdc}\right) \\ & \left(\mathrm{V}_{\mathrm{DS}}=60 \mathrm{Vdc}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{Vdc}, \mathrm{TJ}_{\mathrm{J}}=150^{\circ} \mathrm{C}\right) \end{aligned}$ | IDSS | - | - | $\begin{gathered} 10 \\ 100 \end{gathered}$ | $\mu \mathrm{Adc}$ |
| Gate-Body Leakage Current ( $\left.\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{Vdc}, \mathrm{V}_{\mathrm{DS}}=0 \mathrm{Vdc}\right)$ | IGSS | - | - | $\pm 100$ | nAdc |

ON CHARACTERISTICS (Note 1.)

| Gate Threshold Voltage (Note 1.) $\left(\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{ID}_{\mathrm{D}}=250 \mu \mathrm{Adc}\right)$ <br> Threshold Temperature Coefficient (Negative) | $\mathrm{V}_{\mathrm{GS}}($ th) | 2.0 | $\begin{aligned} & 2.8 \\ & 8.0 \end{aligned}$ | 4.0 | $\begin{gathered} \mathrm{Vdc} \\ \mathrm{mV} /{ }^{\circ} \mathrm{C} \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Static Drain-to-Source On-Resistance (Note 1.) $\left(\mathrm{V}_{\mathrm{GS}}=10 \mathrm{Vdc}, \mathrm{I}_{\mathrm{D}}=37.5 \mathrm{Adc}\right)$ | $\mathrm{R}_{\mathrm{DS}}(\mathrm{on})$ | - | 8.2 | 9.5 | mOhm |
| $\begin{aligned} & \text { Static Drain-to-Source On-Voltage (Note 1.) } \\ & \quad\left(\mathrm{V}_{\mathrm{GS}}=10 \mathrm{Vdc}, \mathrm{I}_{\mathrm{D}}=75 \mathrm{Adc}\right) \\ & \left(\mathrm{V}_{\mathrm{GS}}=10 \mathrm{Vdc}, \mathrm{I}_{\mathrm{D}}=37.5 \mathrm{Adc}, \mathrm{~T}_{\mathrm{J}}=150^{\circ} \mathrm{C}\right) \end{aligned}$ | $\mathrm{V}_{\mathrm{DS}}(\mathrm{on})$ | - | $\begin{aligned} & 0.72 \\ & 0.63 \end{aligned}$ | 0.86 | Vdc |
| Forward Transconductance (Note 1.) (VDS $=15 \mathrm{Vdc}, \mathrm{I}_{\mathrm{D}}=37.5 \mathrm{Adc}$ ) | gFS | - | 40.2 | - | mhos |

DYNAMIC CHARACTERISTICS

| Input Capacitance | $\begin{gathered} \left(\mathrm{V}_{\mathrm{DS}}=\right. \\ \left.\underset{\mathrm{f}}{25 \mathrm{Vdc}, \mathrm{~V}_{\mathrm{GS}}}=0 \mathrm{MHz}\right) \end{gathered}$ | Ciss | - | 3220 | 4510 | pF |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Capacitance |  | Coss | - | 1020 | 1430 |  |
| Transfer Capacitance |  | Crss | - | 234 | 330 |  |

SWITCHING CHARACTERISTICS (Note 2.)

| Turn-On Delay Time | $(\mathrm{V} D \mathrm{~F}=30 \mathrm{Vdc}, \mathrm{ID}=75 \mathrm{Adc}$, <br> $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{Vdc}, \mathrm{R}_{\mathrm{G}}=9.1 \Omega$ ) (Note 1.) | $t_{d}(0 n)$ | - | 16 | 25 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Rise Time |  | $\mathrm{tr}_{r}$ | - | 112 | 155 |  |
| Turn-Off Delay Time |  | $\mathrm{td}_{\mathrm{d} \text { (off) }}$ | - | 90 | 125 |  |
| Fall Time |  | $t_{f}$ | - | 100 | 140 |  |
| Gate Charge | $\begin{gathered} \left(\mathrm{V}_{\mathrm{DS}}=48 \mathrm{Vdc}, \mathrm{I} \mathrm{D}=75 \mathrm{Adc},\right. \\ \left.\mathrm{V}_{\mathrm{GS}}=10 \mathrm{Vdc}\right)(\text { Note } 1 .) \end{gathered}$ | QT | - | 92 | 130 | nC |
|  |  | $\mathrm{Q}_{1}$ | - | 14 | - |  |
|  |  | $\mathrm{Q}_{2}$ | - | 44 | - |  |

## SOURCE-DRAIN DIODE CHARACTERISTICS

| Forward On-Voltage | (IS $=75 \mathrm{Adc}, \mathrm{V}_{\mathrm{GS}}=0 \mathrm{Vdc}$ ) (Note 1.) ( $\mathrm{IS}=75 \mathrm{Adc}, \mathrm{V}_{\mathrm{GS}}=0 \mathrm{Vdc}, \mathrm{T}_{\mathrm{J}}=150^{\circ} \mathrm{C}$ ) | $\mathrm{V}_{\text {SD }}$ | - | $\begin{aligned} & 1.0 \\ & 0.9 \end{aligned}$ | $1.1$ | Vdc |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Reverse Recovery Time | $\begin{aligned} & \left(\mathrm{IS}=75 \mathrm{Adc}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{Vdc},\right. \\ & \mathrm{dl} / \mathrm{dtt}=100 \mathrm{~A} / \mu \mathrm{ss})(\text { Note } 1 .) \end{aligned}$ | trr | - | 77 | - | ns |
|  |  | $\mathrm{ta}_{\mathrm{a}}$ | - | 49 | - |  |
|  |  | $t_{b}$ | - | 28 | - |  |
| Reverse Recovery Stored Charge |  | QRR | - | 0.16 | - | $\mu \mathrm{C}$ |

1. Pulse Test: Pulse Width $\leq 300 \mu \mathrm{~s}$, Duty Cycle $\leq 2 \%$.
2. Switching characteristics are independent of operating junction temperatures.

## NTP75N06, NTB75N06



Figure 1. On-Region Characteristics


Figure 2. Transfer Characteristics


Figure 3. On-Resistance vs. Gate-to-Source Voltage


Figure 4. On-Resistance vs. Drain Current and Gate Voltage


Figure 6. Drain-to-Source Leakage Current vs. Voltage

## NTP75N06, NTB75N06



Figure 7. Capacitance Variation

$\mathrm{R}_{\mathrm{G}}$, GATE RESISTANCE ( $\Omega$ )
Figure 9. Resistive Switching Time Variations vs. Gate Resistance


Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

$\mathrm{V}_{\text {SD }}$, SOURCE-TO-DRAIN VOLTAGE (V)
Figure 10. Diode Forward Voltage vs. Current


Figure 11. Maximum Rated Forward Biased Safe Operating Area


Figure 12. Maximum Avalanche Energy vs. Starting Junction Temperature

## NTP75N06, NTB75N06



Figure 13. Thermal Response

## NTP75N06, NTB75N06

## PACKAGE DIMENSIONS

TO-220 THREE-LEAD<br>TO-220AB<br>CASE 221A-09<br>ISSUE AA



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
CONTROLLING DIMENSION: INCH.
2. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

| DIM | INCHES |  | MILLIMETERS |  |
| :---: | ---: | ---: | ---: | ---: |
|  | MIN | MAX | MIN | MAX |
| A | 0.570 | 0.620 | 14.48 | 15.75 |
| B | 0.380 | 0.405 | 9.66 | 10.28 |
| C | 0.160 | 0.190 | 4.07 | 4.82 |
| D | 0.025 | 0.035 | 0.64 | 0.88 |
| F | 0.142 | 0.147 | 3.61 | 3.73 |
| G | 0.095 | 0.105 | 2.42 | 2.66 |
| H | 0.110 | 0.155 | 2.80 | 3.93 |
| J | 0.018 | 0.025 | 0.46 | 0.64 |
| K | 0.500 | 0.562 | 12.70 | 14.27 |
| L | 0.045 | 0.060 | 1.15 | 1.52 |
| N | 0.190 | 0.210 | 4.83 | 5.33 |
| Q | 0.100 | 0.120 | 2.54 | 3.04 |
| R | 0.080 | 0.110 | 2.04 | 2.79 |
| S | 0.045 | 0.055 | 1.15 | 1.39 |
| T | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | --- | 1.15 | --- |
| Z | --- | 0.080 | --- | 2.04 |

STYLE 5:
PIN 1. GATE
2. DRAIN
. SOURCE
SOURC

## NTP75N06, NTB75N06

## PACKAGE DIMENSIONS

D2PAK
CASE 418B-03 ISSUE D


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

|  | INCHES |  | MILLIMETERS |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |  |  |
| A | 0.340 | 0.380 | 8.64 | 9.65 |  |  |
| B | 0.380 | 0.405 | 9.65 | 10.29 |  |  |
| C | 0.160 | 0.190 | 4.06 | 4.83 |  |  |
| D | 0.020 | 0.035 | 0.51 | 0.89 |  |  |
| E | 0.045 | 0.055 | 1.14 |  |  |  |
| G | 0.100 |  | BSC | 2.54 |  | BSC |
| H | 0.080 | 0.110 | 2.03 |  |  |  |
| J | 0.018 | 0.025 | 2.79 |  |  |  |
| K | 0.090 | 0.110 | 2.29 | 0.64 |  |  |
| S | 0.575 | 0.625 | 14.60 | 15.88 |  |  |
| V | 0.045 | 0.055 | 1.14 | 1.40 |  |  |

STYLE 2:
PIN 1. GATE
2. DRAIN
3. SOURCE
4. DRAIN

## NTP75N06, NTB75N06

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